

Crescent Optoelectronic (Shenzhen) Co., Ltd.

DATA SHEET

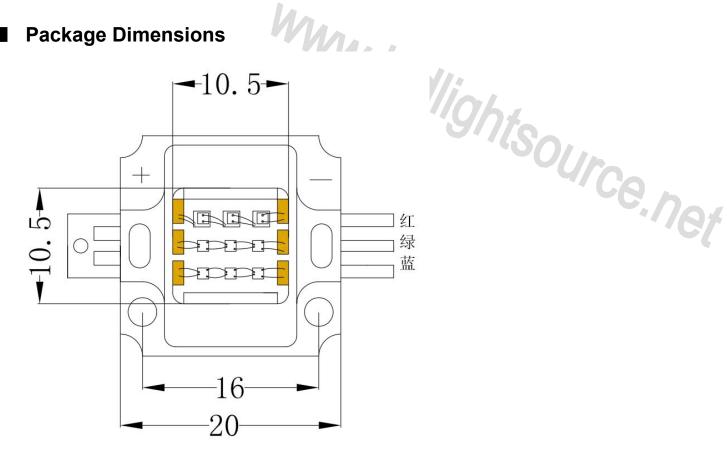


Parameter	Symbol	Ratings	Units	
Power Dissipation	P _D	10	W	
Continuous Forward Current	l _F	350	mA	
Peak Forward Current [2]	I _F (Peak)	700	mA	
LED Junction Temperature	Τ _J	125	°C	
Reverse Voltage	V_{R}	50	V	
Operating Temperature Range	T _{OPR}	-30°C To +60°C		
Storage Temperature Range	T _{STG}	-30°C To +60°C		
Manual Soldering Temperature	T _{SOL}	350°C± 20°C For 3 Seconds		
Soldering on a heat plate	T _{SOL}	190°C± 10°C For 20Seconds		
ESD Sensitivity	ESD	2600V HBM		

■ Electrical/Optical Characteristics (At T_A=25°C)

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Parameter	Symbol	Conditions	Red	Green	Blue	Units
Luminous Intensity	Ф	I _F =350mA	120	180	45	lm
Color Temperature	λd	I _F =350mA	620	520	460	nm
Forward Voltage	V _F	I _F =350mA	7	11	11	V
Color Rendering index	Ra	I _F =350mA				
Thermal Resistance Junction To Board	RO _{J-B}	I _F =350mA	10	10	10	°C/W
50% Power Angle	20½	I _F =350mA	140	140	140	deg
Reverse Current	I _R	V _R =50V	5	5	5	μΑ

Package Dimensions



Notes(备注):

- 1.All dimensions are in millimeters.
- 2. Tolerance is ±0.25 unless otherwise noted.

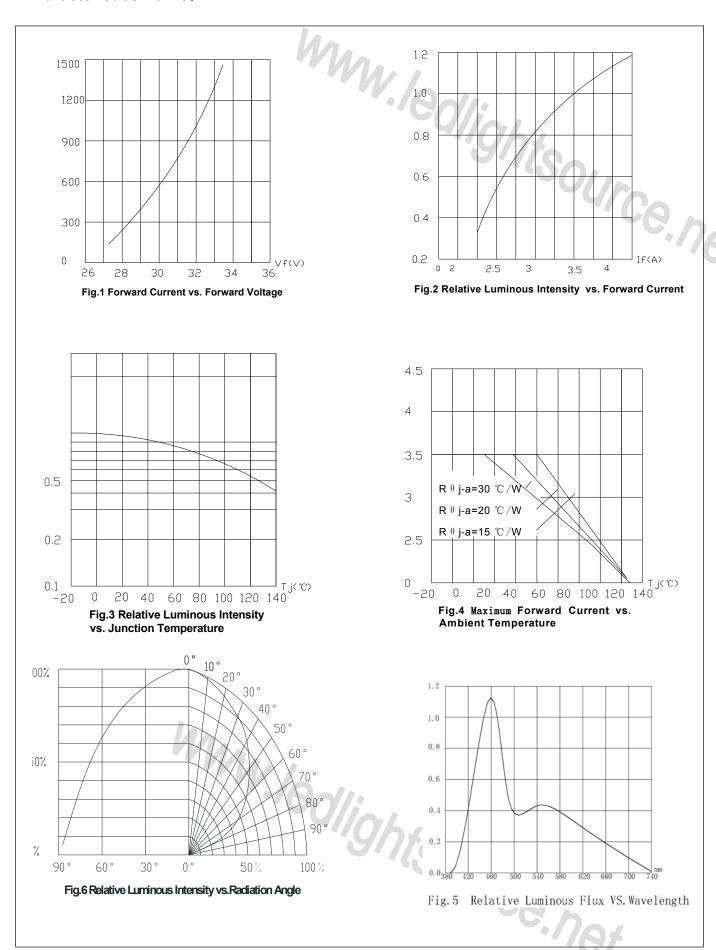
Feature

- ◆Feature• 10W RGB High Power LED
- Package : Emitter Package
- Viewing Angle (2Θ_{1/2}):140°
- •Colloid Color: Water Clear

Applications

- **♦**Commercial Lighting
- ◆ Advertisement
- ◆Architectural Lighting
- **Street Lamps**

■ Characteristics Curve:



Packing Standard

Company:



CAUTIONS:

The LEDs are devices which are materialized by combining Blue LEDs and special phosphors. Consequently the color of the LEDs is changed a little by an operating current. Care should be taken after due consideration when using LED's.

(1) Moisture Proof Package:

When moisture is absorbed into the SMT package it may vaporize and expand during soldering .There is a possibility that this can cause exfoliation of the contacts and damage to the optical characteristics of the LEDs. For this reason, the moisture proof package is used to keep Moisture to a minimum in the package.

(2) Storage Conditions

Before opening the package:

The LEDs should be kept at 30° C or less and 60%RH or less. The LEDs should be used with in a year. When storing the LEDs, moisture proof packaging with absorbent material (silica gel) is recommended. After opening the package:

The LEDs should be kept at 30°C or less and 50%RH or less. The LEDs should be soldered within 168 hours (7days) after opening the package. If unused LEDs remain, they should be stored in moisture proof packages, such as sealed containers with packages of moisture absorbent material (silica gel). It is also recommended to return the LEDs to the original moisture proof bag and to reseal the moisture proof bag again.

If the moisture absorbent material (silica gel) has faded away or the LEDs have exceeded the storage time. Baking treatment should be performed using the following conditions.

Baking treatment : more than 48 hours at $80 \pm 5^{\circ}$ C/ 4h~12h (Humidity in accordance with the different environments)

(3) Heat Generation

Thermal design of the end product is of paramount importance. Please consider the heat generation of the LED when making the system design. The coefficient of temperature increase per input electric power is affected by the thermal resistance of the circuit board and density of LED placement on the board as well as other components. The operating current should be decided after considering the ambient maximum temperature of LEDs.

(4) Cleaning

It is recommended that ethanol alcohol be used as a solvent for cleaning the LED 's. when using other solvents, it should be confirmed beforehand whether the solvents will dissolve the package and the resin or not. Freon solvents should not be used to clean the LEDs because of worldwide regulations.

(5) Static Electricity

Static electricity or surge voltage damages the LEDs.

It is recommended that a wrist band or an anti-electrostatic glove be used when handling the LEDs. All devices, equipments and machineries must be properly grounded. It is recommended that measures be taken against surge voltage to the equipment that mounts the LED's .When inspecting the final products in which LEDs were ssembled. It is recommended to check. Whether the assembled LEDs are damaged by static electricity or not. It is easy to find Static-damaged LED's by a light –on test or a VF test at a lower current (below 20 mA is recommended). Damaged LEDs will show some unusual characteristics such as the leak current. Remarkably increases, the forward voltage becomes lower, or the LEDs do not light at the low Current.